

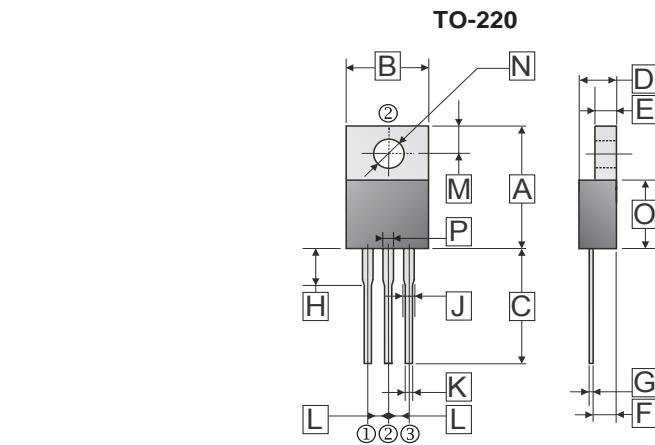
RoHS Compliant Product
A suffix of "C" specifies halogen free

FEATURES

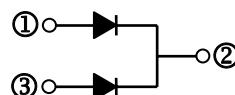
- Super low forward voltage drop
- Low reverse current
- High current capability
- High reliability
- High surge current capability
- Epitaxial construction

MECHANICAL DATA

- Case: Molded plastic
- Epoxy: UL94V-0 rate flame retardant
- Lead: Lead solder able per MIL-STD-202 method 208 guaranteed
- Polarity: As Marked
- Mounting position: Any
- Weight: 1.93 grams (approximate)



Dimensions in millimeters



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	14.22	16.51	J	0.7	1.78
B	9.65	10.67	K	0.38	1.02
C	12.50	14.75	L	2.39	2.69
D	3.56	4.90	M	2.50	3.43
E	0.51	1.45	N	3.10	4.09
F	2.03	2.92	O	8.38	9.65
G	0.31	0.76	P	0.89	1.45
H	3.5	4.5			

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Rating	Unit
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	60	V
Working Peak Reverse Voltage	V_{RSM}	60	V
Maximum DC Blocking Voltage	V_{DC}	60	V
Maximum Average Forward Rectified Current	I_F	10	A
		20	
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	200	A
Maximum Instantaneous Forward Voltage	V_F	0.57	V
		0.52	
Maximum DC Reverse Current at Rated DC Blocking Voltage ³	I_R	0.12	mA
		10	
Typical Junction Capacitance ¹	C_J	620	pF
Typical Thermal Resistance ²	$R_{\theta JC}$	4	°C / W
Voltage Rate Of Change (Rated V_R)	dv / dt	10000	V / μs
Operating Temperature Range T_J	T_J	-50 ~ +150	°C
Storage Temperature Range T_{STG}	T_{STG}	-50 ~ +150	°C

Notes:

1. Measured at 1MHz and applied reverse voltage of 5.0V D.C.
2. Thermal Resistance Junction to Case.
3. Pulse test: 300μs pulse width, 1% duty cycle.

RATINGS AND CHARACTERISTIC CURVES

